



Material Content Data Sheet



Sales Product Name		IGP50N60T		Issued		4. July 2019		
MA#		MA002167764						
Package		PG-TO220-3-1		Weight*		2032.85 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	5.465	0.27	0.27	2688	2688
leadframe	inorganic material	phosphorus	7723-14-0	0.245	0.01		120	
	non noble metal	iron	7439-89-6	0.816	0.04		402	
	non noble metal	copper	7440-50-8	815.335	40.10	40.15	401079	401601
	non noble metal	aluminium	7429-90-5	5.437	0.27	0.27	2674	2674
wire	non noble metal	aluminium	7429-90-5	5.437	0.27	0.27	2674	2674
encapsulation	organic material	carbon black	1333-86-4	5.899	0.29		2902	
	plastics	epoxy resin	-	112.073	5.51		55131	
	inorganic material	silicondioxide	60676-86-0	471.885	23.21	29.01	232130	290163
leadfinish	non noble metal	tin	7440-31-5	21.462	1.06	1.06	10558	10558
plating	inorganic material	phosphorus	7723-14-0	0.001	0.00		1	
	non noble metal	nickel	7440-02-0	0.244	0.01	0.01	120	121
solder	non noble metal	antimony	7440-36-0	0.375	0.02		185	
	noble metal	silver	7440-22-4	0.939	0.05		462	
	non noble metal	tin	7440-31-5	2.440	0.12	0.19	1200	1847
heatspreader	inorganic material	phosphorus	7723-14-0	0.177	0.01		87	
	non noble metal	iron	7439-89-6	0.590	0.03		290	
	non noble metal	copper	7440-50-8	589.466	29.00	29.04	289971	290348
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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